

CONTRACT-APPLICATION FOR PARTICIPATION

Intermediary:

SWIFT code: IRVTUS3N; ABA routing code: 021000018; THE BANK OF NEW YORK MELLON, 225 LIBERTY STREET, NEW YORK, NY, UNITED STATES

Account with institution:

DBDBRSBG; BANCA INTESA A.D. BEOGRAD, 7B MILENTIJA POPOVICA

Beneficiary Customer:

IBAN RS35160513029832167965; MIRKO MITIĆ; VOJVODE VLAHOVIĆA 47S/9, 11000 BEOGRAD
Republic of Serbia

Remittance information (mandatory field)

*Global Invention Forum 2026
Limassol, Republic of Cyprus
14-15 October, 2026.*

Participant/organization name:			
Tel:	Fax:	e-mail: website:	
Chief of the organization:			
Legal address:			
Correspondence address:			
Current currency account		Corresponding account	
Bank			
Provided services:	Price	Quantity	Cost
Registration fee for participation in the Global Invention Forum. ¹	500 €		
Additionally: Participation of an additional representative from the organization in the business program of the Forum (without presentation of an extra project)	150 €		
Exposition place (booth) at the Forum venue (can be purchased additionally upon the will of the participant), includes: 1 table, 2 chairs, facial board, electricity, internet access	300 €		
Correspondence participation: Includes participation in the Invention competition and the Certificate of the Global Invention Forum (participation might be provided with an exposition booth as an extra option)	350 €		
TOTAL AMOUNT			

⁽¹⁾Participation in Global Invention Forum service includes:

- Participation of 1 representative in the International scientific-practical conference on relevant issues of the invention, patent-licensing activities and innovative activity and the business program of the Forum;
- Participation of 1 project in the International exhibition of intellectual property or intellectual property designations: inventions, computer programs, databases and industrial samples, trademarks and brand names – products and services manufactured under the proper trademark (brand), logotypes, corporate identity;
- Placement of the information about 1 exhibit in Catalogue of the Forum (up to 10 lines, font Times New Roman, size 12); Placement of the information about 1 exhibit in Catalogue of the Forum (up to 10 lines, font Times New Roman, size 12);
- Participation package: 1 badge of Forum participant which enables the participation in all the events of the Forum Business Program, 1 Catalogue of the Forum; 1 Program of the Forum, 1 diploma of Forum participant, informational and promotional materials;
- The opportunity to present the project in the form of open presentation on the respective platform of the Forum determined by the organisers;
- Participation of 1 project in the competition in the respective nomination;
- Participation of 1 representative of participating organization in the Official Award Ceremony;
- Assistance in negotiations with International Jury and Expert Council.

Applications to be submitted until **September 10th, 2026**

Payment is to be made within 10 bank days after the bill is issued. The Organizer accepts materials for work only after complete payment of the bill.

In case of refusal of participation in the Forum less than 30 days before its official opening the Participant pays to the Organizer penalty amounting to 25% of the contract price.

All disputes arising from this Contract shall be resolved according to applicable international law.

Hereby the Participant reconfirms his intention to participate in the Salon and acknowledges all clauses of the present contract.

Participant:
Head of the organization

Organizer:
Official representative of
Global Invention Forum

_____/_____
Signature

_____/Mirko Mitic/
Signature

Stamp

Stamp

Date “ ____ ” ____ 20__

Forum directory office doesn't take any responsibilities for the logistics expenses of the Participant as well as expenses for food. These expenses are a subject to be paid by the participating organization.

Members of the International Innovation Club “Archimedes” get extra privileges if application is submitted before the deadline.

Participants who submit the application before July 30th, 2026 are entitled to get 10% discount.